

CES2305-VB Datasheet

P-Channel 20-V (D-S) MOSFET

MOSFET PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
	0.035 at V _{GS} = - 10 V	- 5 ^e				
- 20	0.043 at V _{GS} = - 4.5 V	- 5 ^e	10 nC			
	0.061 at V _{GS} = - 2.5 V	- 4.8				

FEATURES





TrenchFET® Power MOSFET

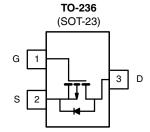
100 % R_q Tested

• Compliant to RoHS Directive 2002/95/EC

ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Load Switch
- PA Switch
- · DC/DC Converters



Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 20	V		
Gate-Source Voltage		V _{GS}	± 12	v	
	T _C = 25 °C		- 5 ^e		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	- 4.8		
Continuous Diam Current (1) = 100 (0)	T _A = 25 °C	'U	- 4.5 ^{b, c}		
	T _A = 70 °C		- 3.5 ^{b, c}	A	
Pulsed Drain Current	I _{DM}	- 18			
Continuous Source-Drain Diode Current	T _C = 25 °C	la	- 2.1		
Continuous Source-Drain Diode Current	T _A = 25 °C	l _S —	- 1.0 ^{b, c}		
	T _C = 25 °C		2.5		
Maximum Power Dissipation	T _C = 70 °C	P _D	1.6	w	
Maximum Fower Dissipation	T _A = 25 °C	' D	1.25 ^{b, c}	VV	
	T _A = 70 °C		0.8 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	≤5 s	R _{thJA}	75	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	40	50	J 0/VV		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under steady state conditions is 166 °C/W.
- e. Package limited.



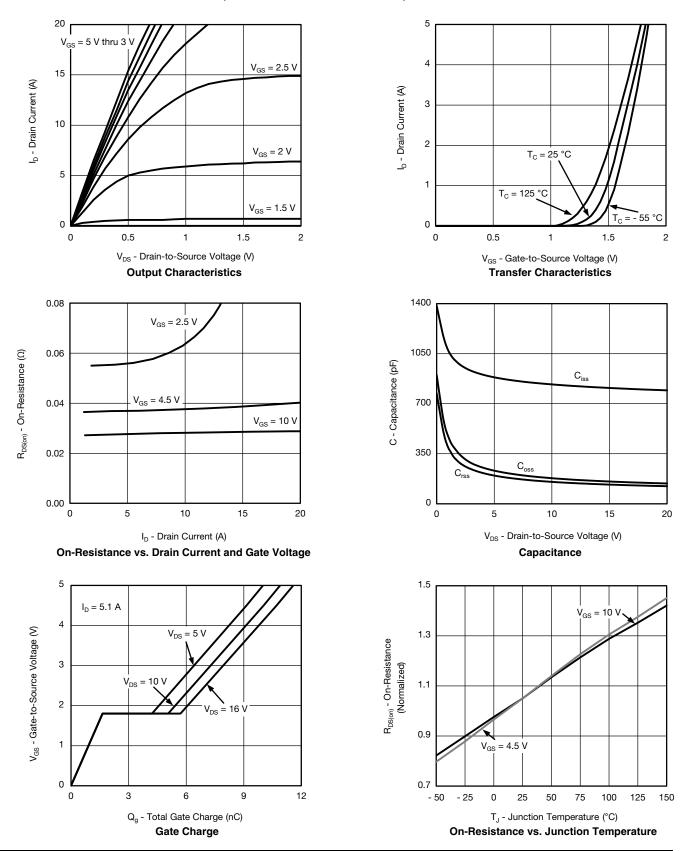
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	ΔV _{DS} /T _J		- 13.4		mV/°(
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.9		IIIV/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.5		- 1.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
7 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	1	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 18			Α	
		V _{GS} = - 10 V, I _D = - 5.1 A		0.035			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 4.5 A		0.043		Ω	
		$V_{GS} = -2.5 \text{ V}, I_D = -3.7 \text{ A}$		0.061			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 5.1 A		15		S	
Dynamic ^b					l		
Input Capacitance	C _{iss}			835		pF	
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		180			
Reverse Transfer Capacitance	C _{rss}			155			
T		V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 5.1 A		10			
Total Gate Charge	Q_g			6.4		nC	
Gate-Source Charge	Q_{gs}	V _{DS} = - 10 V, V _{GS} = - 2.5 V, I _D = - 5.1 A		1.7			
Gate-Drain Charge	Q_{gd}			3.4			
Gate Resistance	R_{g}	f = 1 MHz	0.9	4.4	8.8	Ω	
Turn-On Delay Time	t _{d(on)}			22	33		
Rise Time	t _r	$V_{DD} = -10 \text{ V, R}_{L} = 2.4 \Omega$		20	30		
Turn-Off Delay Time	t _{d(off)}	$I_D = -4.1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		28	42	ns	
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristic	cs				L		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 2.1		
Pulse Diode Forward Current ^a	I _{SM}				- 20	A	
Body Diode Voltage	V _{SD}	I _S = - 4.1 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			23	35	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			12	20	nC	
Reverse Recovery Fall Time	t _a	$I_F = -4.1 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		15			
Reverse Recovery Rise Time	t _b			8		ns	

Notes:

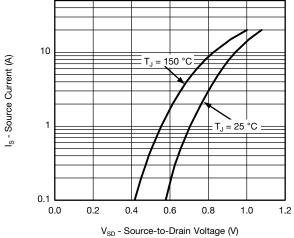
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

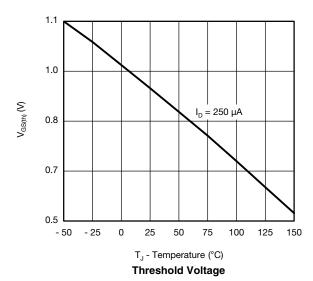


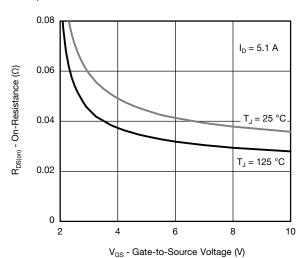




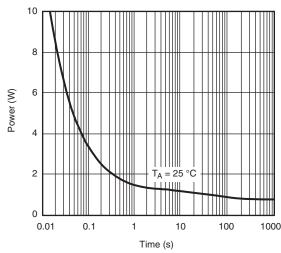


Source-Drain Diode Forward Voltage



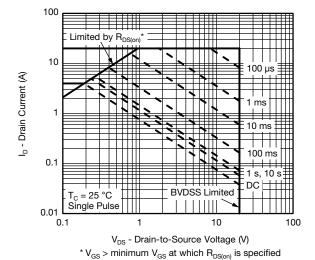


On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

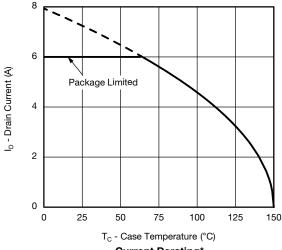
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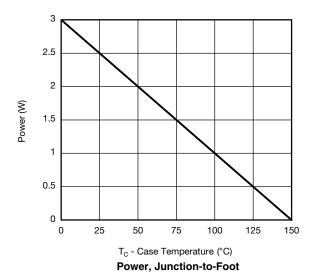
服务热线:400-655-8788

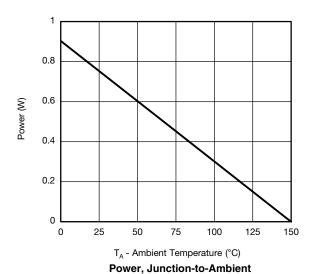
Safe Operating Area





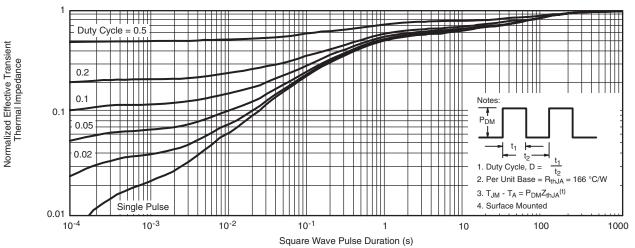




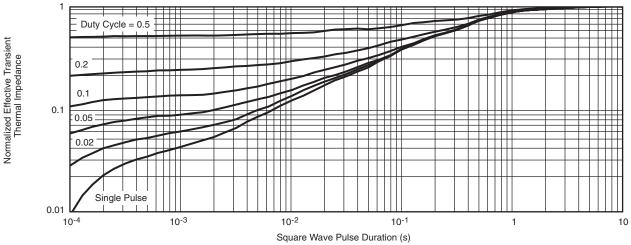


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





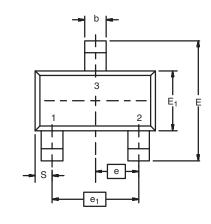


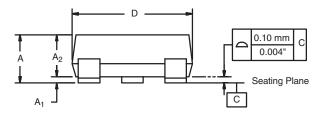


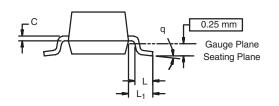
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD





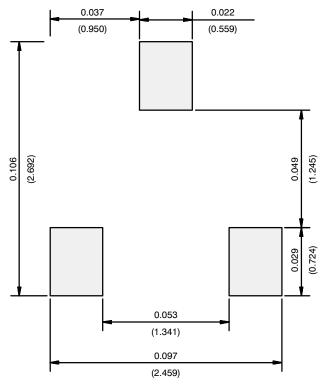


Dim	MILLIMETERS		INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K. 09-	Jul-01	•			

DWG: 5479



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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